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FDP8D5N10C / FDPF8D5N10C N-Channel Shielded Gate PowerTrench[®] MOSFET

100 V, 76 A, 8.5 mΩ

Features

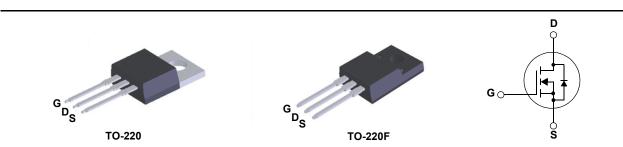
- Max $r_{DS(on)}$ = 8.5 m Ω at V_{GS} = 10 V, I_D = 76 A
- Extremely Low Reverse Recovery Charge, Qrr
- 100% UIL Tested
- RoHS Compliant

General Description

This N-Channel MV MOSFET is produced using ON Semiconductor's advanced PowerTrench[®] process that incorporates Shielded Gate technology. This process has been optimized to minimize on-state resistance and yet maintain superior switching performance with best in class soft body diode.

Applications

- Synchronous Rectification for ATX / Server / Telecom PSU
- Motor drives and Uninterruptible Power Supplies
- Micro Solar Inverter



MOSFET Maximum Ratings T_C = 25 °C unless otherwise noted.

Param Drain to Source Voltage	lieter		FDP8D5N10C	FDPF8D5N10C	Units	
Drain to Source Voltage			•.•.••	FDFF0D3N10C	Units	
			100	100	V	
Gate to Source Voltage			±20	±20	V	
Drain Current -Continuous	T _C = 25°C	(Note 3)	76	76*	А	
-Continuous	T _C = 100°C	(Note 3)	54	54*		
-Pulsed	-	(Note 1)	304	304*		
Single Pulse Avalanche Energy		(Note 2)	181		mJ	
Power Dissipation	T _C = 25°C		107	35	W	
Power Dissipation	T _A = 25°C		2.4	2.4		
Operating and Storage Junction Temperature Range			-55 to +175	-55 to +175	°C	
:	Drain Current -Continuous -Continuous -Pulsed Single Pulse Avalanche Energy Power Dissipation Power Dissipation	Drain Current-Continuous $T_C = 25^{\circ}C$ -Continuous $T_C = 100^{\circ}C$ -PulsedSingle Pulse Avalanche EnergyPower Dissipation $T_C = 25^{\circ}C$ Power Dissipation $T_A = 25^{\circ}C$ Operating and Storage Junction Temperature Range	Drain Current-Continuous $T_C = 25^{\circ}C$ (Note 3)-Continuous $T_C = 100^{\circ}C$ (Note 3)-Pulsed(Note 1)Single Pulse Avalanche Energy(Note 2)Power Dissipation $T_C = 25^{\circ}C$ Power Dissipation $T_A = 25^{\circ}C$ Operating and Storage Junction Temperature Range	Drain Current-Continuous $T_C = 25^{\circ}C$ (Note 3)76-Continuous $T_C = 100^{\circ}C$ (Note 3)54-Pulsed(Note 1)304Single Pulse Avalanche Energy(Note 2)18Power Dissipation $T_C = 25^{\circ}C$ 107Power Dissipation $T_A = 25^{\circ}C$ 2.4Operating and Storage Junction Temperature Range-55 to +175	Drain Current -Continuous $T_C = 25^{\circ}C$ (Note 3) 76 76* -Continuous $T_C = 100^{\circ}C$ (Note 3) 54 54* -Pulsed (Note 1) 304 304* Single Pulse Avalanche Energy (Note 2) 181 Power Dissipation $T_C = 25^{\circ}C$ 107 35 Power Dissipation $T_A = 25^{\circ}C$ 2.4 2.4 Operating and Storage Junction Temperature Range -55 to +175 -55 to +175	

Thermal Characteristics

Symbol	Parameter	FDP8D5N10C	FDPF8D5N10C	Units	
$R_{\theta JC}$	Thermal Resistance, Junction to Case	1.4	4.2	°C AA/	
$R_{ ext{ heta}JA}$	Thermal Resistance, Junction to Ambient	62.5	62.5	°C/W	

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDP8D5N10C	FDP8D5N10C	TO-220	-	-	50 units
FDPF8D5N10C	FDPF8D5N10C	TO-220F	-	-	50 units

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units
Off Chara	cteristics					
BV _{DSS}	Drain to Source Breakdown Voltage	I _D = 250 μA, V _{GS} = 0 V	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, referenced to 25 °C		57		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	V _{DS} = 80 V, V _{GS} = 0 V			1	μA
		V _{DS} = 80 V, T _J = 150°C			500	μA
I _{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			±100	nA
On Chara	cteristics					
V _{GS(th)}		V _{GS} = V _{DS} , I _D = 130 μA	2.0	3.0	4.0	V
r _{DS(on)}		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 76 \text{ A}$		7.4	8.5	mΩ
9 _{FS}	Forward Transconductance	V _{DS} = 5 V, I _D = 76 A		68		S
-	Characteristics			1765	2475	۶Ę
C _{iss}	Input Capacitance	− V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz			2475	pF
C _{oss}	Output Capacitance			1010	1415	pF
C _{rss}	Reverse Transfer Capacitance		0.1	16	25 1.6	pF Ω
Rg	Gate Resistance		0.1	0.8	1.0	Ω
Switching	g Characteristics					
t _{d(on)}	Turn-On Delay Time			12	22	ns
t _r		V_{DD} = 50 V, I _D = 76 A, V _{GS} = 10 V, R _{GEN} = 6 Ω		11	20	ns
t _{d(off)}	Turn-Off Delay Time			18	28	ns
t _f	Fall Time	Ĩ		4	10	ns
Qg	Total Gate Charge	$V_{GS} = 0 V \text{ to } 10 V$ $V_{DD} = 50 V,$		25	34	nC
Q _{gs}	Gate to Source Gate Charge	V _{DD} = 50 V, I _D = 76 A		9		nC
Q _{gd}	Gate to Drain "Miller" Charge	10 - 70 A		5		nC
Q _{oss}	Output Charge	V _{DD} = 50 V, V _{GS} = 0 V		68		nC
Drain-Sou	urce Diode Characteristic					
I _S	Maximum Continuous Drain to Source Diode Forward Current			-	76	А
I _{SM}	Maximum Pulsed Drain to Source Diode Forward Current		-	-	304	Α
V _{SD}	Source to Drain Diode Forward Voltage	V _{GS} = 0 V, I _S = 76 A		1.0	1.3	V
t _{rr}		V _{GS} = 0 V, V _{DD} = 50 V, I _F = 76 A,		58	92	ns
Q _{rr}		$dI_F/dt = 100 \text{ A}/\mu\text{s}$		53	85	nC
••						

Q_{rr} Notes:

t_{rr}

1. Pulsed Id please refer to Figure 11 & Figure 12 "Forward Bias Safe Operating Area" for more details.

Reverse Recovery Charge

Reverse Recovery Time

2. E_{AS} of 181 mJ is based on starting T_J = 25 °C, L = 3 mH, I_{AS} = 11 A, V_{DD} = 100 V, V_{GS} = 10 V. 100% test at L = 0.3 mH, I_{AS} = 25 A.

3. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.

 $dI_F/dt = 300 \text{ A}/\mu \text{s}$

 V_{GS} = 0 V, V_{DD} = 50 V, I_F = 76 A,

51

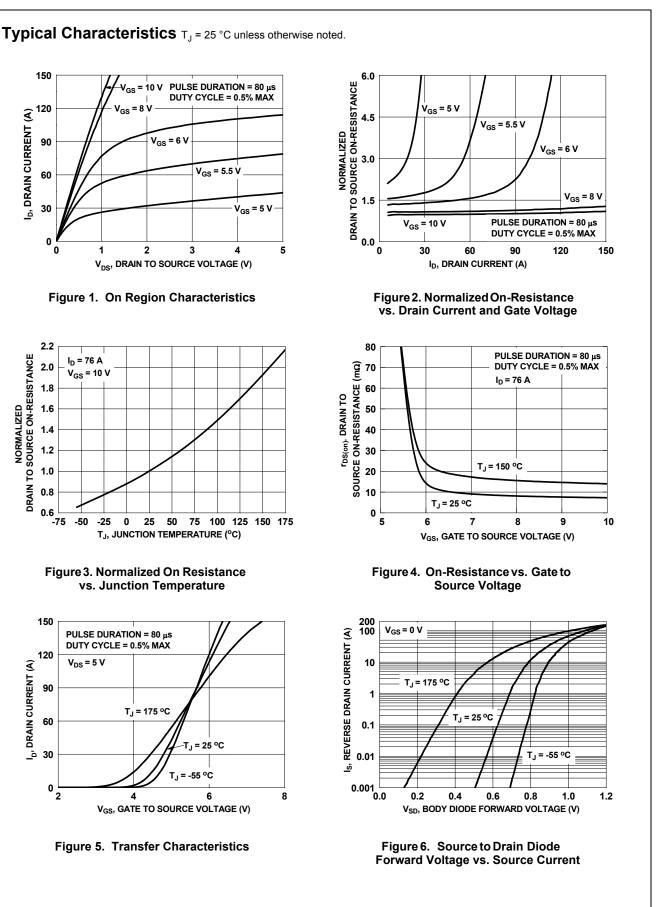
141

81

226

ns

nC

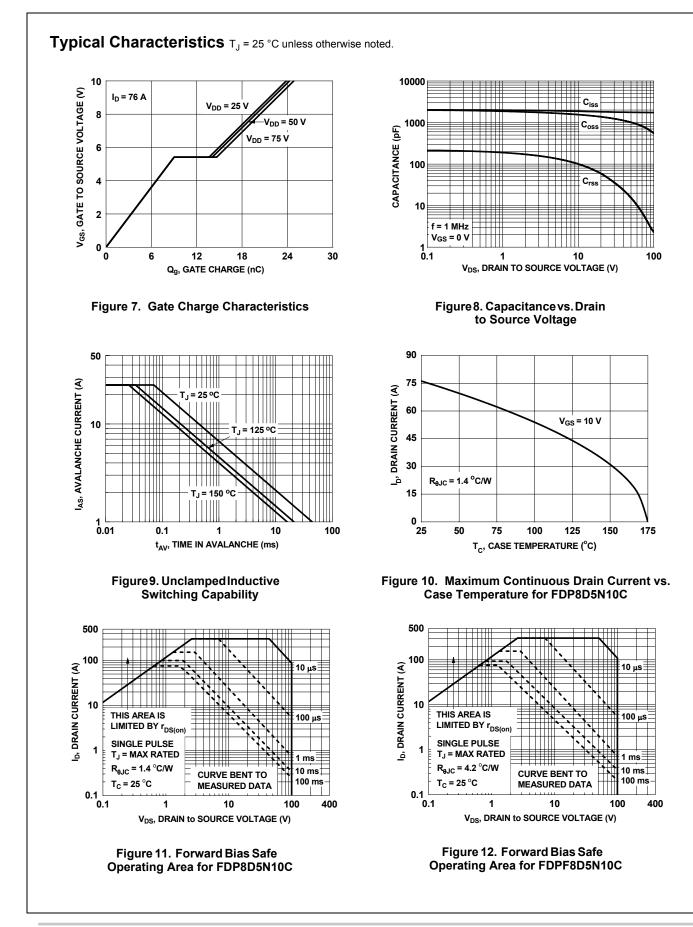


I_D, DRAIN CURRENT (A)

DRAIN TO SOURCE ON-RESISTANCE

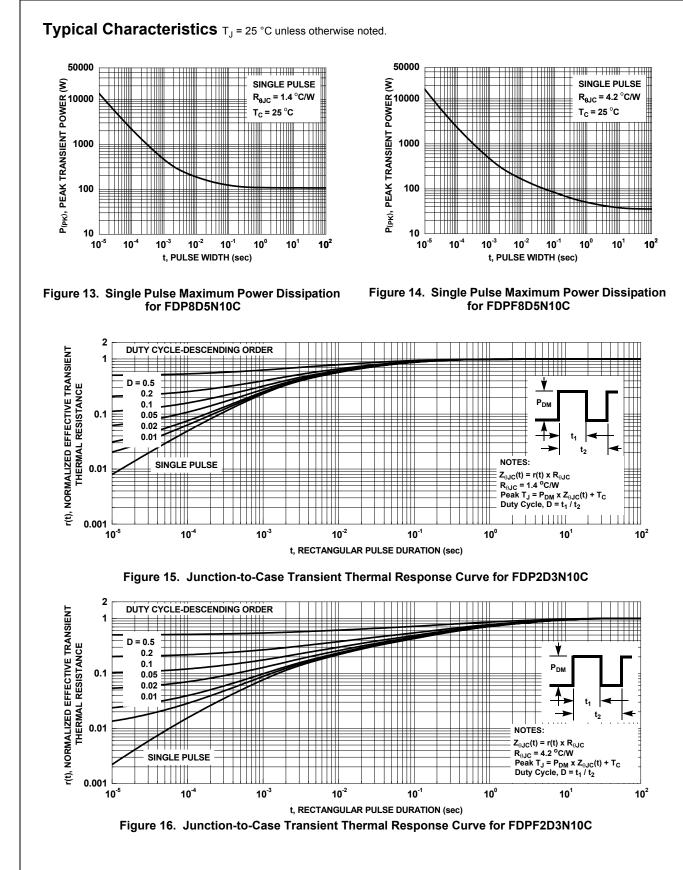
I_D, DRAIN CURRENT (A)

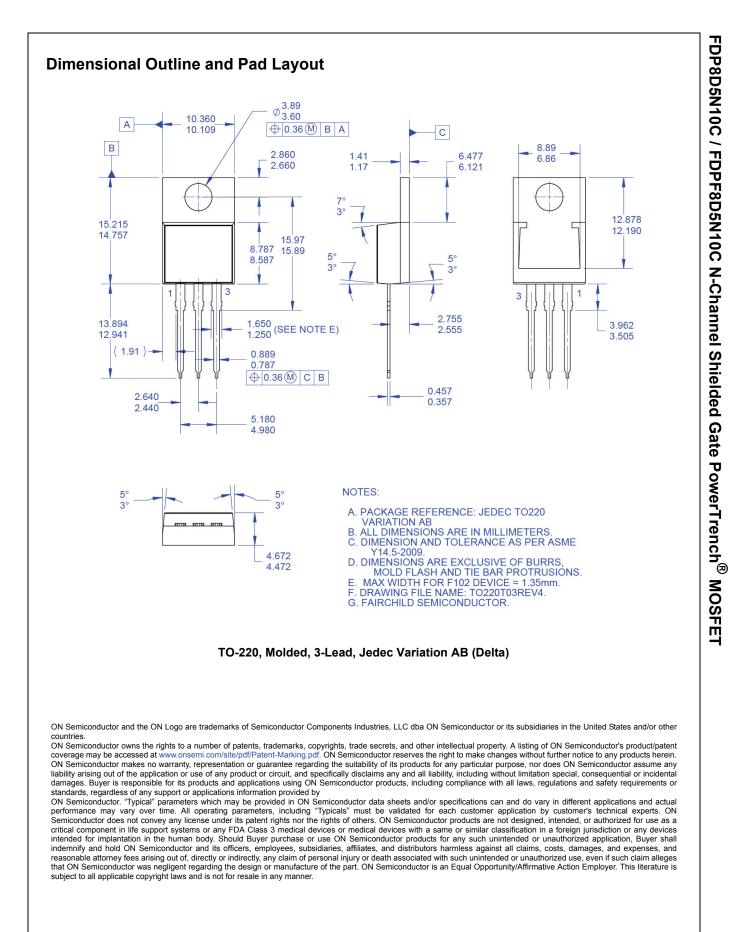
NORMALIZED

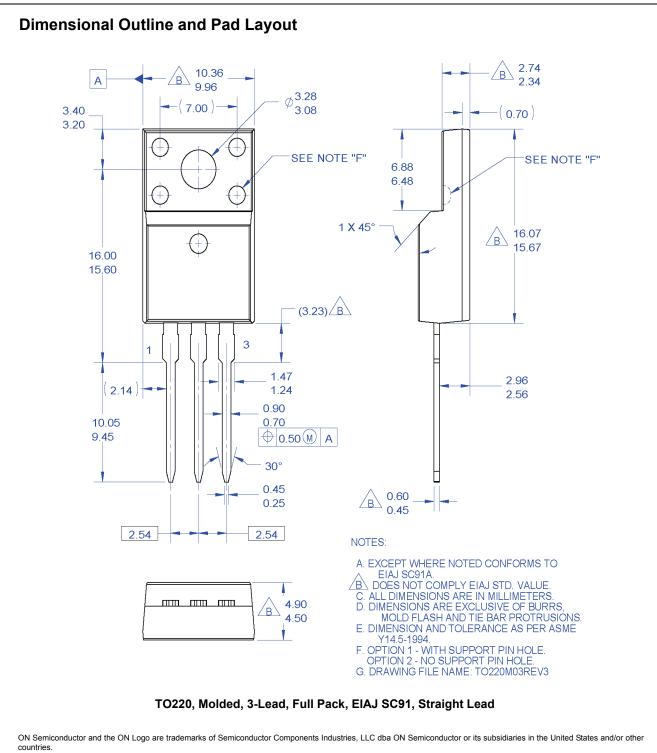


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